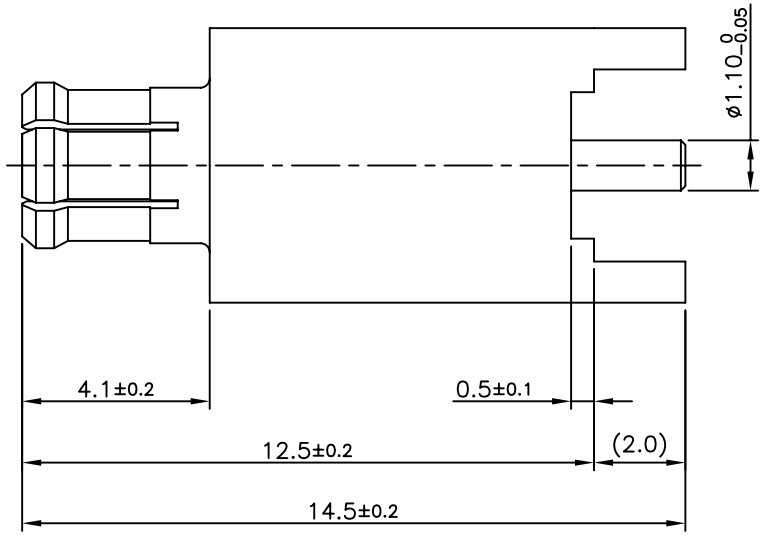
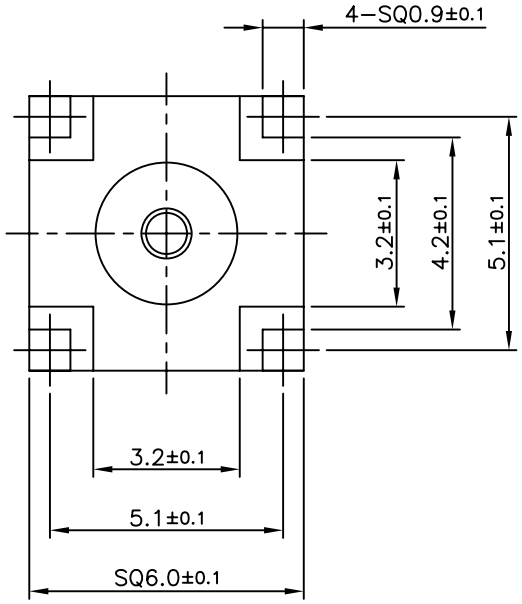
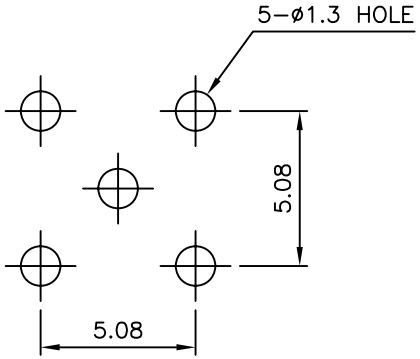
REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2020.09.09.







MOUNTING HOLE
(SCALE 4:1)

■ JACK + BODY 억지끼움 받침 JIG
- DEQ00149

NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE
4	JACK	1	BeCu C17300	Gold Plate	DJA00241-5/1
3	INSULATOR	1	TEFLON		DIN03150-N/1
2	CONTACT	1	MBsBD C3604BD-F	Gold Plate	DCT04136-5/1
1	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD04633-5/2

TOLERANCE	Decimal ±0.2	DATE	2020. 09. 09
	Angle ±1°	APPROVED BY	I.C.KIM
		CHECKED BY	
MATERIAL	———	DRAWN BY	S.Y.EUN
FINISH	———	SCALE 6/1	UNIT mm

KJ COMTECH
KJ COMTECH CO.,LTD.
RF & MICROWAVE TECHNOLOGY
Tel : 82-32-347-8015
Fax : 82-32-347-8017

TITLE
MCX50 PCB PS-4R

A4

DWG NO. CN03936-7/2

REVISION I R

SHEET 1 of 1